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April 1st, 2010 Renesas Electronics Corporation

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MOS FIELD EFFECT TRANSISTOR μ PA2702TP

SWITCHING N-CHANNEL POWER MOS FET

DESCRIPTION

The μ PA2702TP, which has a heat spreader, is N-Channel MOS Field Effect Transistor designed for DC/DC converter and power management applications of notebook computers.

FEATURES

- · Low on-state resistance RDS(on)1 = $9.5 \text{ m}\Omega$ MAX. (VGS = 10 V, ID = 7.0 A) RDS(on)2 = 15.1 m Ω MAX. (VGS = 4.5 V, ID = 7.0 A)
- Low Ciss: Ciss = 900 pF TYP. (VDS = 10 V, VGS = 0 V)
- Small and surface mount package (Power HSOP8)

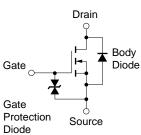
ORDERING INFORMATION

PART NUMBER	PACKAGE	
μPA2702TP	Power HSOP8	

PACKAGE DRAWING (Unit: mm) 5. 6. 7. 8. 9 : Drain H 6.0 ±0.3 4.4 ±0.15 △ 0.10 S

ABSOLUTE MAXIMUM RATINGS (TA = 25°C, Unless otherwise noted, All terminals are connected.)

Drain to Source Voltage (Vss = 0 V)	Voss	30	V	
Gate to Source Voltage (Vps = 0 V)	Vgss	±20	V	EQUIVALENT CIRCUIT
Drain Current (DC) (Tc = 25°C)	ID(DC)1	±35	Α	
Drain Current (DC) (T _A = 25°C) Note1	ID(DC)2	±14	Α	Drain ♀
Drain Current (pulse) Note2	D(pulse)	±65	Α	Body
Total Power Dissipation (Tc = 25°C)	P _{T1}	22	W	Gate Diode
Total Power Dissipation (T _A = 25°C) Note1	P_{T2}	3	W	***
Channel Temperature	Tch	150	°C	Gate
Storage Temperature	T_{stg}	-55 to +150	°C	Protection Source Diode
Single Avalanche Current Note3	las	16	Α	
Single Avalanche Energy Note3	Eas	25.6	mJ	



- **Notes 1.** Mounted on a glass epoxy board (1 inch x 1 inch x 0.8 mm), PW = 10 sec
 - **2.** PW \leq 10 μ s, Duty Cycle \leq 1%
 - 3. Starting Tch = 25°C, VdD = 15 V, Rg = 25 Ω , L = 100 μ H, Vgs = 20 \rightarrow 0 V

Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

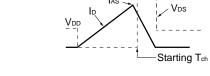
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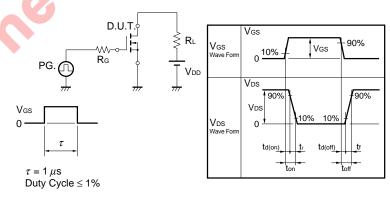
ELECTRICAL CHARACTERISTICS (TA = 25°C, Unless otherwise noted, All terminals are connected.)

CHARACTERISTICS	SYMBOL	TEST CONDITIONS		TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	loss	Vps = 30 V, Vgs = 0 V			10	μΑ
Gate Leakage Current	Igss	Vgs = ±20 V, Vps = 0 V			±10	μΑ
Gate Cut-off Voltage	V _{GS(off)}	V _{DS} = 10 V, I _D = 1 mA	1.5	2.0	2.5	V
Forward Transfer Admittance	yfs	V _{DS} = 10 V, I _D = 7.0 A	7	13		S
Drain to Source On-state Resistance	RDS(on)1	Vgs = 10 V, Ip = 7.0 A		7.6	9.5	mΩ
	RDS(on)2	VGS = 4.5 V, ID = 7.0 A		11.3	15.1	mΩ
	RDS(on)3	Vgs = 4.0 V, ID = 7.0 A		12.9	17.2	mΩ
Input Capacitance	Ciss	V _{DS} = 10 V		900		pF
Output Capacitance	Coss	Vgs = 0 V		380		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		120		pF
Turn-on Delay Time	td(on)	V _{DD} = 15 V, I _D = 7.0 A		9		ns
Rise Time	tr	Vgs = 10 V		5		ns
Turn-off Delay Time	t d(off)	R _G = 10 Ω		35		ns
Fall Time	tf			8		ns
Total Gate Charge	Q _G	V _{DD} = 15 V		9		nC
Gate to Source Charge	Qgs	Vgs = 5 V		3		nC
Gate to Drain Charge	Q _{GD}	Ib = 13 A		4		nC
Body Diode Forward Voltage	V _{F(S-D)}	I _F = 13 A, V _G s = 0 V		0.82	1.2	V
Reverse Recovery Time	trr	I _F = 13 A, V _G s = 0 V		28		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/ μs		22		nC

TEST CIRCUIT 1 AVALANCHE CAPABILITY

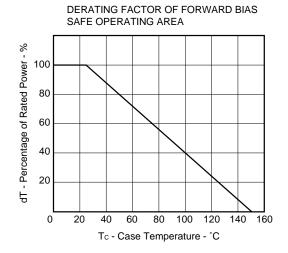


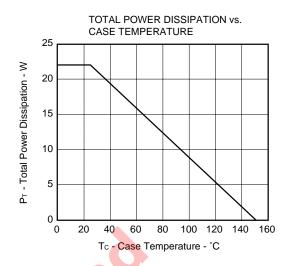
TEST CIRCUIT 2 SWITCHING TIME



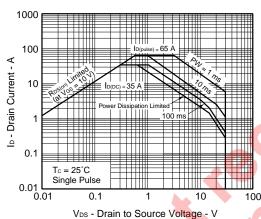
TEST CIRCUIT 3 GATE CHARGE

TYPICAL CHARACTERISTICS (TA = 25°C)

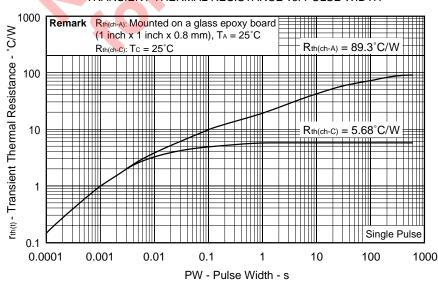




FORWARD BIAS SAFE OPERATING AREA

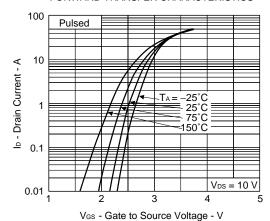


TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

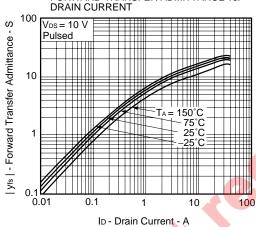


3

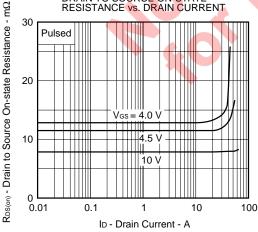
FORWARD TRANSFER CHARACTERISTICS



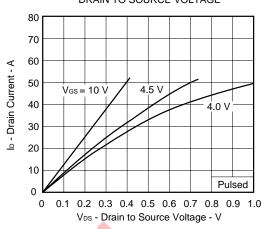
FORWARD TRANSFER ADMITTANCE vs.



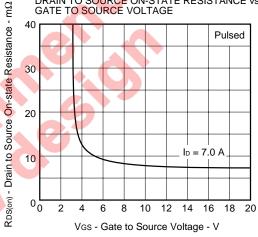
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



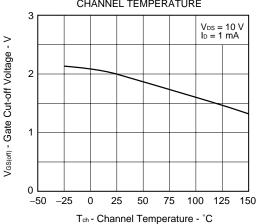
DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE

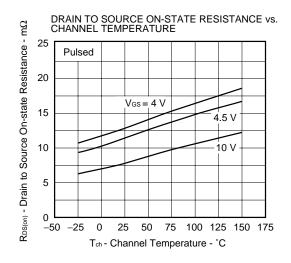


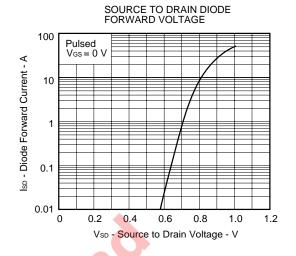
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

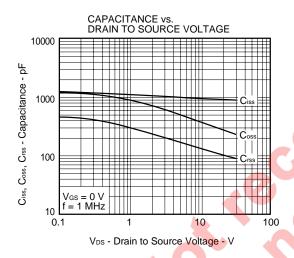


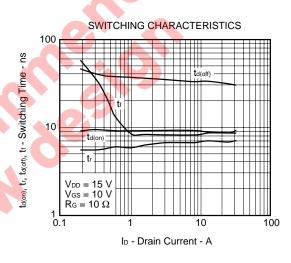
GATE CUT-OFF VOLTAGE vs. CHANNEL TEMPERATURE

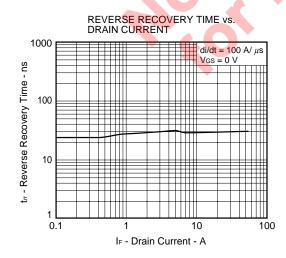


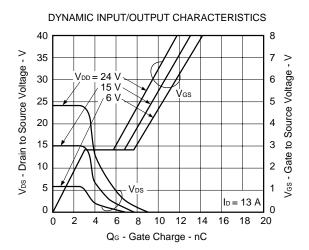












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